

AABG-H Series

Features

- Qualified to AEC-Q200.
- Fe base metal material core provides large saturation current.
- Metallization on Ferrite Core results in excellent shock resistance and damage-free durability.
- Closed magnetic circuit design reduces leakage flux and Electro Magnetic Interference(EMI).
- Low DCR decreases power loss, small and slim take up less PCB real estate.
- Automatic production ensures high quality and consistency.
- RoHS compliance.

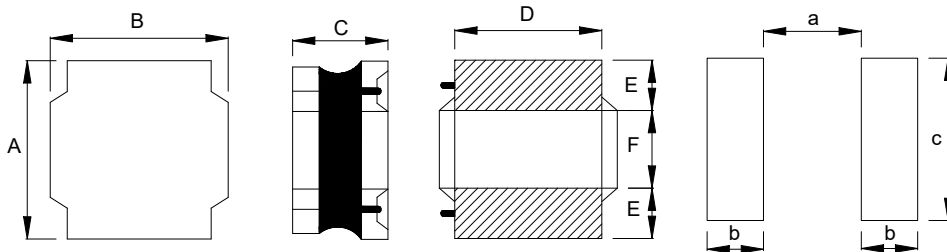
Applications

- LED Lighting & Smart phone.
- Blue -ray disc recorders, set top box.
- Next-generation mobile devices with multifunction such as adding color TV and digital movie cameras.
- Flat-screen TVs, blue-ray disc recorders set top box.
- Notebooks, desktop computers, servers, graphic cards.
- Portable gaming devices, personal navigation systems, personal multimedia devices.

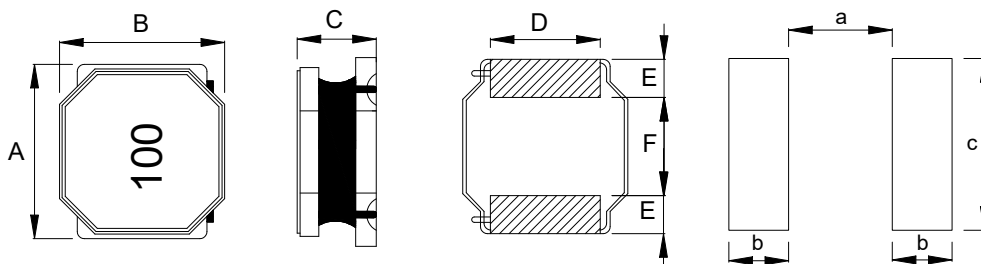
Test Equipment and Conditions

- Inductance is measured with IM3536 LCR meter or equivalent.
- Operating temperature range -40°C to +125°C.(Including self - temperature rise).
- DC current(Irms)that will cause an approximate ΔT of 40°C.
- DC current(Isat)that will cause L0 to drop approximately 35%.
- For AABG02 & AABG25 size inductors, absolute maximum voltage: DC 25V;
For AABG03 & AABG04 size inductors, absolute maximum voltage: DC 40V;

External dimensions (Unit:m/m)



Type	A	B	C	D Typ.	E Typ.	F Typ.	a Typ.	b Typ.	c Typ.	Q'TY/Reel
AABG02H10	2.1±0.3	1.7±0.3	1.05Max	1.7	0.7	0.7	0.4	1.0	2.0	2000
AABG25H10	2.5±0.3	2.2±0.3	1.05Max	1.65	0.8	0.9	0.6	1.1	1.95	2000
AABG25H12	2.5±0.3	2.2±0.3	1.25Max	1.65	0.8	0.9	0.6	1.1	1.95	2000



Type	A	B	C	D Typ.	E Typ.	F Typ.	a Typ.	b Typ.	c Typ.	Q'TY/Reel
AABG03H12	3.0±0.2	3.0±0.2	1.35Max	2.55	0.9	1.2	1.1	1.0	3.4	2000
AABG04H12	4.0±0.2	4.0±0.2	1.35Max	3.5	1.3	1.4	1.1	1.6	3.8	4500
AABG04H20	4.0±0.2	4.0±0.2	2.00Max	3.5	1.0	2.0	1.3	1.5	3.8	3000

Part Number Code

AABG 02 H 10 N R24
 A B C D E F

A: Series Name Power Inductors
 B: Dimensions(mm) 02: 2.1 x 1.7
 C: Materials H Type
 D: Thickness(mm) 10: 1.05 Max
 E: Tolerance N: ±30% M: ±20%
 F: Inductance R24=0.24uH

AABG-H Series

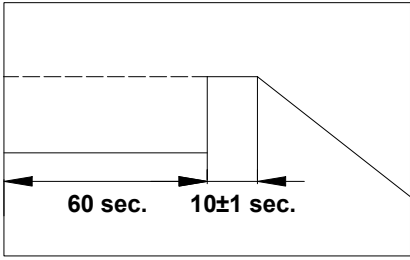
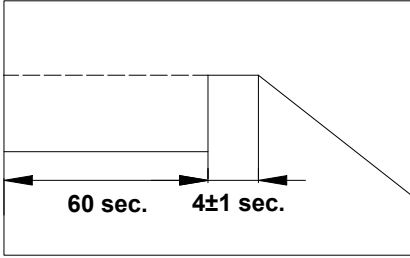
Part Number	Inductance(μH) @1MHz/1V	DC Resistance (Ω) Max.	Min Self-resonant Frequency(MHz)	Heat Rating Current I _{rms} (A) Max.	Saturation Current I _{sat} (A) Max.
AABG02H10NR24	0.24	0.039	145	3.02	4.54
AABG02H10NR39	0.39	0.053	104	4.10	4.10
AABG02H10NR47	0.47	0.055	102	2.72	4.03
AABG02H10NR68	0.68	0.064	77	2.53	3.53
AABG02H10M1R0	1.0	0.089	70	2.07	3.38
AABG02H10M1R5	1.5	0.128	45	1.72	1.97
AABG02H10M2R2	2.2	0.192	39	1.46	1.92
AABG02H10M4R7	4.7	0.423	25	0.91	1.21
AABG02H10M5R6	5.6	0.500	17	0.90	1.00
AABG02H10M6R8	6.8	0.540	16	0.53	0.73
AABG02H10M100	10.0	0.824	15	0.65	0.81
AABG25H10NR33	0.33	0.038	117	3.52	4.83
AABG25H10NR47	0.47	0.044	80	3.23	4.43
AABG02H10NR56	0.56	0.055	66	2.50	3.80
AABG25H10NR68	0.68	0.058	65	2.77	3.23
AABG25H10M1R0	1.0	0.075	46	2.51	3.12
AABG25H10M1R5	1.5	0.105	40	2.02	2.62
AABG25H10M2R2	2.2	0.153	26	1.51	1.91
AABG25H10M3R3	3.3	0.233	24	1.20	1.60
AABG25H10M4R7	4.7	0.300	19	1.11	1.31
AABG25H10M100	10.0	0.530	12	0.85	0.93
AABG25H12NR24	0.24	0.029	117	4.10	6.55
AABG25H12NR33	0.33	0.036	104	3.40	5.41
AABG25H12NR47	0.47	0.040	89	3.00	5.00
AABG25H12NR68	0.68	0.050	67	3.18	3.73
AABG25H12M1R0	1.0	0.060	52	3.03	3.70
AABG25H12M1R5	1.5	0.090	35	2.40	2.92
AABG25H12M2R2	2.2	0.117	32	1.96	2.60
AABG25H12M3R3	3.3	0.190	25	1.82	1.77
AABG25H12M4R7	4.7	0.256	23	1.26	1.66

AABG-H Series

Part Number	Inductance(μ H) @1MHz/1V	DC Resistance (Ω) Max.	Min Self-resonant Frequency(MHz)	Heat Rating Current I _{rms} (A) Max.	Saturation Current I _{sat} (A) Max.
AABG25H12M6R8	6.8	0.364	16	0.97	1.20
AABG25H12M100	10.0	0.480	12	0.85	1.15
AABG03H12NR33	0.33	0.027	107	4.10	7.20
AABG03H12NR47	0.47	0.033	86	4.00	6.10
AABG03H12NR68	0.68	0.040	63	3.80	5.80
AABG03H12M1R0	1.0	0.054	51	2.80	4.00
AABG03H12M1R5	1.5	0.074	37	2.00	3.20
AABG03H12M2R2	2.2	0.108	28	1.90	2.20
AABG03H12M3R3	3.3	0.150	25	1.60	1.70
AABG03H12M4R7	4.7	0.230	20	1.40	1.50
AABG03H12M6R8	6.8	0.340	16	1.10	1.40
AABG03H12M100	10.0	0.460	12	0.90	1.00
AABG04H12NR33	0.33	0.032	113	4.50	8.00
AABG04H12NR47	0.47	0.040	96	4.20	7.50
AABG04H12NR68	0.68	0.040	70	4.10	5.00
AABG04H12M1R0	1.0	0.058	55	3.50	4.50
AABG04H12M1R2	1.2	0.064	48	3.20	4.00
AABG04H12M1R5	1.5	0.070	38	2.60	3.90
AABG04H12M2R2	2.2	0.079	28	2.50	2.80
AABG04H12M3R3	3.3	0.125	23	1.90	2.00
AABG04H12M4R7	4.7	0.166	19	1.70	1.80
AABG04H12M6R8	6.8	0.226	17	1.50	1.60
AABG04H12M100	10.0	0.335	12	1.30	1.50
AABG04H12M220	22.0	0.679	7	0.85	0.90
AABG04H20NR47	0.47	0.022	72	7.00	10.0
AABG04H20NR68	0.68	0.035	57	5.00	8.70
AABG04H20M1R0	1.0	0.026	37	5.10	8.50
AABG04H20M1R5	1.5	0.036	30	4.50	7.20
AABG04H20M2R2	2.2	0.048	25	4.20	6.10
AABG04H20M3R3	3.3	0.072	19	3.50	4.20
AABG04H20M4R7	4.7	0.108	17	2.50	4.00
AABG04H20M6R8	6.8	0.156	13	2.10	3.00
AABG04H20M100	10.0	0.216	11	1.70	2.80

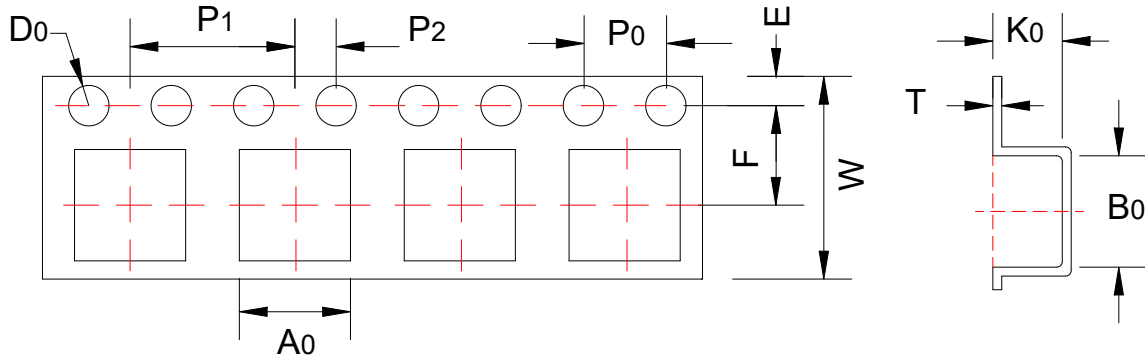
Reliability Test

Item	Specifications	Test conditions
High temperature storage test	No visible mechanical damage. Inductance change: Within $\pm 10\%$.	<p>Temperature: $125 \pm 2^\circ\text{C}$. Duration: 1000hrs. Measured at room temperature after placing for 24 ± 4 hrs.</p> <p>The graph shows a temperature profile over time. The y-axis is labeled 'Temp' with markers at 125°C, 25°C, and 0°C. The x-axis is labeled 'Test Time' with markers at 1000H and 24H. The temperature starts at 125°C, remains constant for 1000 hours, then drops to 25°C and remains constant for 24 hours, finally reaching 0°C.</p>
Temperature cycling test	No visible mechanical damage. Inductance change: Within $\pm 10\%$.	<p>Condition for 1 cycle. Step1: $-40 \pm 2^\circ\text{C}$ 30min Min. Step2: $125 \pm 2^\circ\text{C}$, transition time 1min Max. Step3: $125 \pm 2^\circ\text{C}$ 30min Min. Step4: Low temp, transition time 1min Max. Number of cycles: 1000. Measured at room temperature after placing for 24 ± 4 hrs.</p> <p>The graph shows a temperature profile over time. The y-axis is labeled 'Temp' with markers at 125°C, 25°C, 0°C, and -40°C. The x-axis is labeled 'Time'. The temperature starts at -40°C, rises to 125°C with a change time of less than 1 minute, remains constant at 125°C for 30 minutes, then drops back to -40°C with a change time of less than 1 minute.</p>
Biased humidity test	No visible mechanical damage. Inductance change: Within $\pm 10\%$.	<p>Humidity : $85\% \pm 3$ RH. Temperature: $85^\circ\text{C} \pm 2^\circ\text{C}$. Duration : 1000hrs. Measured at room temperature after placing for 24 ± 4 hrs.</p>
Operational life test	No visible mechanical damage. Inductance change: Within $\pm 10\%$.	<p>Temperature: $105 \pm 2^\circ\text{C}$. Duration : 1000hrs. Measured at room temperature after placing for 24 ± 4 hrs.</p>
Resistance to solvent test	No visible mechanical damage. Inductance change: Within $\pm 10\%$.	Add aqueous wash chemical - OKEM clean or equivalent.

Item	Specifications	Test conditions
Vibration test	No visible mechanical damage. Inductance change: Within $\pm 10\%$.	Oscillation Frequency: 10~2K~10Hz for 20 minute. Total Amplitude:1.52mm $\pm 10\%$. Testing Time:12 hours(20 minutes, 12 cycles each of 3 orientations).
Resistance to soldering heat test	No visible mechanical damage. Inductance change: Within $\pm 10\%$.	Temperature ($^{\circ}\text{C}$): 260 ± 5 (solder temp). Time (s): 10 ± 1 . ramp/immersion and emersion rate: 25mm/s ± 6 mm/s. Number of heat cycles:1. 
Solderability test	More than 95% of the terminal electrode should be covered with solder.	Steam Aging: 8 hours ± 15 min. Preheat: 150 $^{\circ}\text{C}$,60sec. Solder: Sn99.5%-Cu0. 5%. Temperature: 245 $\pm 5^{\circ}\text{C}$. Flux for lead free: Rosin. 9.5%. Dip time: 4 ± 1 sec. Depth: completely cover the termination. 
Terminal strength (SMD) test	No visible mechanical damage.	With the component mounted on a PCB with the device to be tested, apply a 17.7 N (1.8 Kg) force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied radually as not to apply a shock to the component being tested.

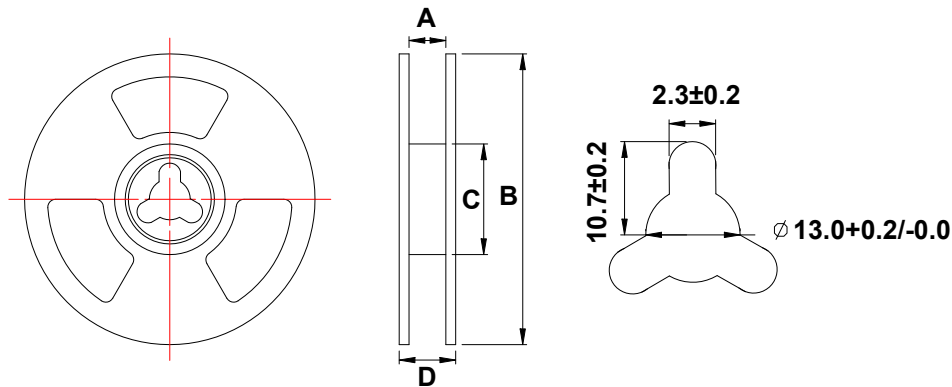
Packaging

Taping Dimensions (Unit: mm)



TYPE	A0	B0	W	E	F	P0	P1	P2	D0	T	K0
AABG02H10	1.9±0.1	2.35±0.1	8.0±0.3	1.75±0.1	3.5±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.5±0.1	0.2±0.05	1.1±0.1
AABG25H10	2.4±0.1	2.8±0.1	8.0±0.3	1.75±0.1	3.5±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.5±0.1	0.2±0.05	1.35±0.1
AABG25H12	2.4±0.1	2.8±0.1	8.0±0.3	1.75±0.1	3.5±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.5±0.1	0.2±0.05	1.35±0.1
AABG03H12	3.3±0.1	3.3±0.1	8.0±0.3	1.75±0.1	3.5±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.5±0.1	0.25±0.05	1.3±0.1
AABG04H12	4.25±0.1	4.25±0.1	12.0±0.3	1.75±0.1	5.5±0.1	4.0±0.1	8.0±0.1	2.0±0.1	1.5±0.1	0.3±0.05	1.4±0.1
AABG04H20	4.25±0.1	4.25±0.1	12.0±0.3	1.75±0.1	5.5±0.1	4.0±0.1	8.0±0.1	2.0±0.1	1.5±0.1	0.3±0.05	2.5±0.1

Reel Dimensions (Unit: mm)

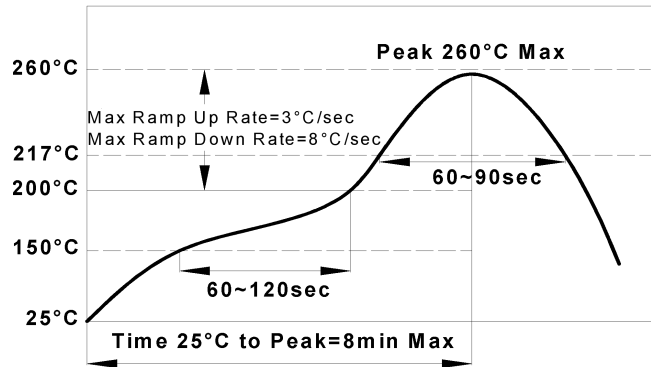


TYPE	A	B	C	D
AABG02H10	8.5±2.0	178.0±2.0	58.0±2.0	10.5±2.0
AABG25H10	8.5±2.0	178.0±2.0	58.0±2.0	10.5±2.0
AABG25H12	8.5±2.0	178.0±2.0	58.0±2.0	10.5±2.0
AABG03H12	8.5±2.0	178.0±2.0	58.0±2.0	10.5±2.0
AABG04H12	12.5±2.0	330.0±2.0	100.0±2.0	16.5±2.0
AABG04H20	12.5±2.0	330.0±2.0	100.0±2.0	16.5±2.0

Recommended Soldering Technologies

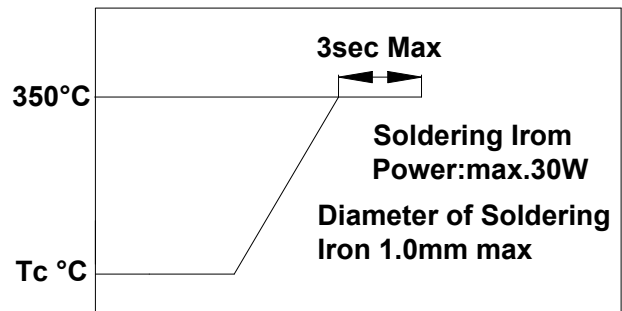
Re-flowing Profile:

- △ Preheat condition: 150~200°C/60~120sec.
- △ Allowed time above 217°C: 60~90sec.
- △ Max temp: 260°C
- △ Max time at max temp: 5sec.
- △ Solder paste: Sn/3.0Ag/0.5Cu
- △ Allowed Reflow time: 2x max



Iron Soldering Profile:

- △ Iron soldering power: Max.30W
- △ Pre-heating: 150°C/60sec.
- △ Soldering Tip temperature: 350°CMax.
- △ Soldering time: 3sec Max.
- △ Solder paste: Sn/3.0Ag/0.5Cu
- △ Max.1 times for iron soldering



[Note: Take care not to apply the tip of the soldering iron to the]